



தமிழ்நாடு தமில்நாடு TAMIL NADU

15.11.2022 NATIONAL ENGINEERING
COLLEGE KOVILPATTI

16AC 715268

V. சங்கரநாதன்
S.R.O. சட்டமன்ற அலுவலகம்
கோவில்பட்டி L.No.6/2009

MEMORANDUM OF UNDERSTANDING

Between

NATIONAL ENGINEERING COLLEGE, KOVILPATTI

(An Autonomous Institution, affiliated to Anna University, Chennai)

and

M/S MAXVY TECHNOLOGIES PRIVATE LIMITED, BENGALURU

This agreement entered on 15th November 2022 between the Department of Electrical & Electronics Engineering, National Engineering College (An Autonomous Institution), K.R.Nagar, Kovilpatti (here in after referred to as "NEC") and M/S MAXVY Technologies Private Limited, having its registered office at 2nd FLOOR, 1197/1, 16th A Main Road, 22nd Cross Rd, Sector 3, HSR Layout, Bengaluru, Karnataka (here in after referred to as "MAXVY") involved in the in the fields of RTL design and Verification IP Solutions.

C. A.

Verdy

It offer services to shape the concept in to products (Silicon Chips), which includes Embedded Product Design, RTL design and Verification, Analog and Mixed Signal System Design and Analysis, Physical Design etc... etc, and also have interest in conducting training, In-plant training and internship program.

AND WHEREAS

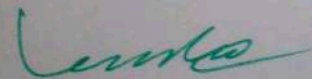
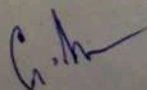
The parties herein now intend to enter into this MoU to facilitate the following objectives through orientation and development for their mutual benefit.

OBJECTIVES/PURPOSE OF THIS MOU:

- (i) To improve the skill set of engineering students in RTL design, Analog layout design, Embedded software/Hardware solution etc.
- (ii) To provide opportunities for our college Electrical and Electronics Engineering (EEE) and Electronics and Communication Engineering (ECE) department students to undergo industrial training through Value Added Courses, In Plant Training and to take up project.
- (iii) To provide Internship for the students.
- (iv) Guidance for preparation of Projects/Proposals
- (v) Knowledge Transfer to students/staff for Consultancy Work

ROLES AND RESPONSIBILITIES OF THE MOU SIGNING COMPANY:

- (i) The Industry shall permit the faculties designated inside their campus for interaction and development of the project.
- (ii) The Industry agrees to participate in curriculum / extra curriculum designing and give guest lecturers for the benefit of students.
- (iii) To organize short term training programs
- (iv) To organize Value Added Courses/Workshop/Seminar once in six months to Electrical and Electronics Engineering (EEE) and Electronics and Communication (ECE) students at the college to enlighten them on the advance telecom /RTL/Design Verification projects and development.
- (v) To supply tools/techniques to the college
- (vi) To provide opportunities for the Electrical and Electronics Engineering (EEE) and Electronics and Communication (ECE) students of the college to undergo industrial training, in plant visits and to take up project works.
- (vii) To provide Internship for best performing Individuals.
- (viii) To identify and help the college in the area of taking up R & D projects.
- (ix) The Company will provide opportunity for placement to the students, if demand exists.



ROLES AND RESPONSIBILITIES OF THE COLLEGE:

- (i) NEC will permit the MAXVY to utilize their facilities.
- (ii) To create the awareness among the students about recent advancement in Electrical and Electronics and Electronics and communication products.
- (iii) To undertake consultancy works.
- (iv) To provide classrooms /LCD Projectors and audio facilities and laboratory facilities as required for the training.
- (v) To train the employees of MAXVY on latest technologies and accommodation and hospitality will be provided by NEC during their training period.
- (vi) To impart theoretical exposure on software's to the employees.
- (vii) NEC further agrees to provide their students for market survey and feasibility study analysis work etc., to connect with the Industry in a mutually agreed time frame.

INTELLECTUAL PROPERTY RIGHTS (IPR)

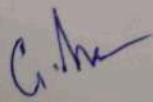
NEC faculty shall maintain integrity of the technique / technology of MAXVY products and process observed during their visit and consultancy work.

TIME FRAME:

This MoU is valid for 3 years from the date of signing and will be renewed for a further period on mutually agreed terms and conditions.

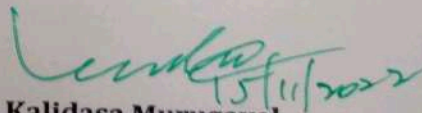
In witness whereof the parties hereto have affixed their signatures to this agreement on this day.

For MAXVY Technologies Private Limited


Muralidhar G
Director - HR



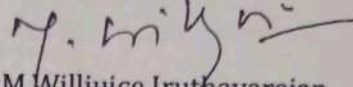
For National Engineering College


Dr.K.Kalidasa Murugavel
Principal
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503

WITNESSES

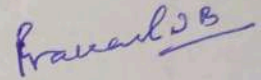
1.

WITNESSES



Dr.M,Willjuice Iruthayarajan,
Professor and Head,
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503

2.



Dr. N.B.Prakash
Professor
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503



असम ASSAM

K 216506

MEMORANDUM OF UNDERSTANDING UNDER INUP-i2i PROGRAM

BETWEEN

INDIAN INSTITUTE OF TECHNOLOGY GUWAHATI

AND

NATIONAL ENGINEERING COLLEGE, KOVILPATTI

1. PREAMBLE

The Indian Institute of Technology Guwahati, set up by an Act of Parliament of India and established in 1994 (hereinafter referred to as "IITG"). Indian Institute of Technology Guwahati, the sixth member of the IIT fraternity, commenced its academic programmes in 1995. IIT Guwahati is officially recognized as an Institute of National Importance by the Government of India.

The Indian Nanoelectronics Users Program (INUP) was conceived and supported by MeitY, Gol and the Office of the PSA (OPSA) as an integral part of the initiative of establishing a Centre for Excellence in Nanoelectronics (CEN) initially at IIT Bombay in 2006. This program was later changed as INUP-Idea to Innovation (INUP-i2i) program and expanded to four other IITs including IITG. The Centre for Nanotechnology at IITG is now a part of INUP-i2i program. It was envisioned that the Nanocenters, built by the teams of technical experts, should be national centres whose facilities are open to

aspiring academic researchers from the country. These "open national nanocenters" would inculcate a spirit of collaboration among researchers and raise the efficiency of operations by bringing in researchers from elsewhere in the country.

And

Whereas, National Engineering College, K.R. Nagar, Kovilpatti, Thoothukudi District, Tamilnadu - 628503 (NEC) at its various engineering, technology and science departments is charged with responsibility of training technical and scientific manpower in various front-line areas of importance for the Nation and is also contributing to the rapidly growing scientific and technological knowledge and professional excellence in Science & Technology by undertaking industrial & applied research and consultancy.

INDIAN INSTITUTE OF TECHNOLOGY GUWAHATI (IITG) and NATIONAL ENGINEERING COLLEGE, KOVILPATTI, hereinafter collectively referred to as 'the Parties' and individually as 'the Party' formally agree on a Memorandum of Understanding (MoU) as follows:

The Dean R&D of Indian Institute of Technology Guwahati (IITG) and the PRINCIPAL OF NATIONAL ENGINEERING COLLEGE, KOVILPATTI, for the purpose of furthering cooperation in education and R&D activities between these two institutions under the INUP-i2i program sponsored by MeitY, GoI, hereby affirm their intent to promote such academic collaborations and to participate in various academic endeavors.

2. OBJECTIVES:

This MoU envisages the fulfilling of the following objectives with the NATIONAL ENGINEERING COLLEGE, KOVILPATTI agreeing to the following:

- i. Start a new course or run an existing course in the general area of nanoelectronics/ semiconductor devices/ nanophotonics/ nanofabrication.
- ii. Start a new program or run an existing program in nanoelectronics/semiconductor devices/ nanophotonics/ nanofabrication.
- iii. Submit a minimum of 2 grant proposals to external funding agencies in the area of nanoelectronics and related areas.
- iv. Conduct a minimum of 2 medium-term research projects at IITG under INUP- i2i Program.
- v. Avail internship for a minimum of two B.Tech/ M.Tech at IITG under INUP- i2i Program.
- vi. Avail the usage of Centre for Nanotechnology (CFN) at IITG by Ph.D./ Master's

Students with a minimum of three (03) users.

vii. Good faith attempts to set up nano facility (through DST FIST/ MeitY or other avenues).

viii. Agrees to provide access to facilities that they have e.g. NATIONAL ENGINEERING COLLEGE, KOVILPATTI mentors/ trains users from smaller institutes located around them.

(a) **SHORT/ MEDIUM TERM projects at CFN, IITG:** Under this program, NATIONAL ENGINEERING COLLEGE PG/ PhD students/ faculty will visit IITG for period of up to 3/6 months to execute short/medium term projects selected by IITG under INUP-i2i program. The selected projects will be supported by IITG as per the norms of INUP-i2i program.

(b) **IITG Faculty support to NATIONAL ENGINEERING COLLEGE, KOVILATTI:** IITG may permit its faculty to visit NATIONAL ENGINEERING COLLEGE, KOVILPATTI for short durations to conduct awareness workshops/seminars under INUP-i2i.

(c) **Short term training programs:** Development and organization of short-term training and certificate courses by IITG and enabling NATIONAL ENGINEERING COLLEGE, KOVILPATTI faculty / staff / students to take part in ongoing continuing education programs and courses of IITG.

(d) **New areas of R&D:** Cooperation from IITG for the development of new areas of R&D at NATIONAL ENGINEERING COLLEGE, KOVILPATTI.

(e) **Guidance in infrastructure development:** Extension of technical cooperation in the form of knowhow from IITG for infrastructural development, management and upgradation of library and teaching / research laboratories facilities at NATIONAL ENGINEERING COLLEGE, KOVILPATTI.

(f) **Joint short-term programs and workshops:** To jointly organize short term continuation programs, seminars, conferences on topics of mutual interest and invite faculty members from both the institutions to participate.

(g) **Use of Logo and name:** Each of the institutions will maintain their independent identity, logo symbol, image and make no other claims in their publicity material, media, websites, which is termed to be beyond the scope and nature of activities as incorporated in this memorandum. Each party will consult with and concur with the other party to use the names of the officials'/faculty members, and the logo for the activities under this MOU including dissemination of results and outcome under this MOU, in public.

3. COORDINATORS:

The Dean R&D, IITG and the Head of NATIONAL ENGINEERING COLLEGE, KOVILPATTI shall be primarily responsible for this cooperation at IITG and NATIONAL ENGINEERING COLLEGE, KOVILPATTI, respectively. They may delegate their authority to coordinators whose responsibility will be to:

(a) initiate action at their respective institutions to implement the provisions of this MoU

(b) coordinate and monitor the activities initiated under this MoU

(c) Undertake official visits to each other institutions to operate articles coming under this MoU.

(d) National regulations and customs shall be mutually respected by all.

4. GENERAL PROVISIONS

(a) This MoU shall have an initial duration of THREE years from the last date of signature, unless either party gives a six-month notice of termination.

(b) This MoU may be extended further, in three-year increments, after review and by mutual written agreement.

(c) This MoU is a non-binding expression of the current intentions of the Parties, and neither Party will incur nor be bound to any legal obligations or expenses hereunder to the other Party until and unless definitive agreements have been negotiated and approved by the management levels of each Party.

5. Financial Obligations: There will be no financial obligations on both Parties under this agreement.

6. Intellectual Property: IITG and NATIONAL ENGINEERING COLLEGE, KOVILPATTI agree to respect each other's right to intellectual PROPERTY. Further, all rights linked to ideas, inventions and patents generated during the MoU, if any, shall remain the common intellectual property of the parties. The Parties shall not pass on or give usage rights of such property to any third Party without the consent of the other Party. Any such research collaboration to be taken up during due course of time under the ambit of this present MoU shall be legitimized by signing an agreement.

7. Dispute Settlement: Any dispute, controversy, or claim arising out of or in relation to this MoU, including the validity, invalidity, breach or termination thereof, shall be settled by the parties amicably through mutual consultations and negotiations.

8. Liability: Except for loss or damages caused through gross negligence or intent, the Parties shall have no liability to each hereunder.

9. Legal Relationship: This MoU shall be construed as a statement of purpose to promote a genuine and mutually beneficial collaboration between the parties. Nothing in this MoU shall be constructed to create any legal relationship between the Parties. Details of specific cooperation will be determined on a case—by—case basis and by mutual agreement consistent with this memorandum of understanding (MoU).

Signed at IIT Guwahati on this ..23.. day of ..May.. month, 2023, in two originals in English language, one for each Party.

In witness thereof, both the parties have caused this MOU to be signed by their duly authorized representatives.

FOR IITG

Signature: _____

Date: _____

Name: Prof. Vimal Katiyar
Designation: Dean R&D
Indian Institute of Technology
Guwahati, Assam, India.

Seal

संकायाध्यक्ष, अनुसंधान एवं विकास
Dean, Research and Development
भारतीय प्रौद्योगिकी संस्थान गुवाहाटी
Indian Institute of Technology Guwahati
गुवाहाटी-781039
Guwahati-781039

Witnesses

FOR IITG

1. Signature: _____

Name: _____

Date: _____

2. Signature: _____

Name: _____

Date: _____

FOR NATIONAL ENGINEERING COLLEGE

Signature: _____

Date: _____

Name: Dr.K.Kalidasa Murugavel
Designation: Principal,
National Engineering College,
Kovilpatti - 628 503

Seal

Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

FOR NATIONAL ENGINEERING COLLEGE

Signature: _____

Name: _____

Date: _____

Signature: _____

Name: _____

Date: _____

भारतीय गैर न्यायिक

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ONE
HUNDRED RUPEES

सत्यमेव जयते

भारत INDIA
INDIA NON JUDICIAL

தமிழ்நாடு தமில்நாடு TAMILNADU

NATIONAL ENGINEERING

COLLEGE

KOVILPATTI

BY 408826

V. *[Signature]*
S.R. Govindarajulu
Kovilpatti, T.N.T. 605 003

மதிப்பு ரூ. 100/-
தேதி: 11/07/19

PREAMBLE

Whereas, National Engineering College, K.R. Nagar, Kovilpatti, Thoothukudi District, Tamilnadu – 628503 (NEC) at its various engineering, technology and science departments is charged with responsibility of training technical and scientific manpower in various front-line areas of importance for the Nation and is also contributing to the rapidly growing scientific and technological knowledge and professional excellence in Science & Technology by undertaking industrial & applied research and consultancy.

Whereas, Mistral Solutions Private Limited, 60, Adarsh Regent, 100 Feet Ring Road, Domlur Extension, Bengaluru, Karnataka – 560071 (MISTRAL) is engaged in developing aero space and defense products, providing engineering design services, and manufacturing homeland security products through research, design, development and consultancy in the field of Electronic System Design, Internet of Things, wireless communication, signal processing, automation and related fields.

[Signature]

[Signature]
11/07/19

WHEREAS, both NEC and MISTRAL, now

- Recognizing the importance of research and development in the areas Electronic System Design, Internet of Things, wireless Communication, Signal Processing, Automation and related fields, as well as imparting industrial training to the engineering/technology students, etc.
- Appreciating the need for creation of large reservoir of highly qualified manpower in all fields related to Electronic System Design, Internet of Things, Wireless Communication, Signal Processing, Automation and allied fields
- Desiring to club their efforts by pooling their expertise and resources,

INTEND to form a nucleus for promoting excellent quality manpower in the fields of engineering, technology and sciences with special emphasis on Electronic System Design, Internet of Things, Wireless Communication, Signal Processing, Automation and related fields etc.

NOW, THEREFORE, in consideration of the mutual promises made herein and of good and valuable consideration, the receipt and sufficiency of which both NEC and MISTRAL hereby acknowledge, NEC and MISTRAL hereby agree to sign a memorandum of understanding (MOU).

ARTICLE - I

SCOPE OF THE MOU

This MOU details the modalities and general conditions regarding collaboration between NEC and MISTRAL for enhancing, within the country, the availability of highly qualified manpower in the areas of Electronic System Design, Internet of Things, Wireless Communication, Signal Processing, Automation and related fields without any prejudice to prevailing rules and regulations in NEC and MISTRAL without any disregard to any mechanism evolved and approved by the competent authorities. The areas of cooperation can be extended through mutual consent.

J. Vijayaraj

[Signature]
10/5/19

ARTICLE-II

TERMS OF INTERACTIONS

Both NEZ and MISTRAL shall motivate interactions between industrial experts, engineers, research fellows, faculty members and students of both the organizations through the following arrangements:

- 1) MISTRAL may involve its personnel as Member of Board of Studies at NEC to design and develop industry oriented curriculum for the students of NEC to satisfy the academic deliverables towards industrial expectation.
- 2) MISTRAL may depute its personnel as visiting faculty at NEC to teach curricular course or specialized topics.
- 3) MISTRAL may offer industrial training to the faculty members of NEC to improve the core competency of the faculty through technology knowhow in Industry in the area of electronic system design, Internet of Things, wireless communication, Signal Processing, Automation and related fields.
- 4) MISTRAL may offer internship and placement to the students of NEC who have successfully completed their courses and recruited by MISTRAL from time to time.
- 5) MISTRAL may avail library, Internet, computational facilities at NEC for doing collaborative work.
- 6) MISTRAL may seek assistance/guidance of NEC faculty member/s as consultant in product/process modification, modernization, trouble shooting, etc.
- 7) MISTRAL may involve its personnel to mentor/guide final year UG students in their product development activity, mini project/project activity which may lead to participation in National/International level competition or publication in reputed science indexed journal or patent.
- 8) MISTRAL may showcase its business activities at the seminar/workshop/conference, etc. at NEC.
- 9) MISTRAL may allow the industrial visits of NEC students to provide them with an exposure to various equipment, instrument, etc.
- 10) MISTRAL and NEC may jointly organize National/International level seminars or project competitions or workshops or conferences in order to bring the Scientists, Industrial delegates, Academic experts, research scholars, young faculty fraternity and student community to a common forum to share their expertise.

V. K. S. Pillai

V. K. S. Pillai
12/11/19

ARTICLE - III

SHARING OF FACILITIES

- 1) NEC and MISTRAL shall permit the sharing software and other materials and components developed in-house in the areas of cooperation, if permissible within the rules governing the two institutions. However, responsibility for safety of software and other materials during the exchange will rest on respective Head of academic department/section.
- 2) NEC and MISTRAL shall provide access to the library facilities to engineers, members of faculty and students as per the prevailing rules and norms in the respective institutes.

TERM AND TERMINATION

This agreement shall remain in effect for a period of one year unless terminated earlier. The Term shall automatically be renewed for another term of one year upon expiry of the first term unless terminated by either party.

CONFIDENTIALITY

All written and oral information communicated to either party by the other, whether before or after the Effective Date, shall be held in strict confidence and used only for purposes of this Agreement. The recipient without the prior written consent of the other party shall disclose no such information, including the provisions of this Agreement, except as required by law. If either party is required to disclose any confidential information of the other party, the party so required shall notify the other party immediately and shall cooperate in seeking a reasonable protective order.

This clause shall not apply to information, which is (i) in the public domain, (ii) already known to the recipient, (iii) developed independently or (iv) received from a third party without similar restriction and without breach of this or a similar agreement.

RELATIONSHIP OF PARTIES

Neither party shall act or represent itself directly or by implication as an agent of the other party.

ASSIGNMENT

Neither party may or can assign any of its rights and obligations under this Agreement without the prior written consent of the other.

S. Vigneshwara

Leela
1.7.19

ENTIRE AGREEMENT

This Agreement constitutes the final, entire, and exclusive agreement between the parties with respect to their subject matter.

IN WITNESS WHEREOF the Parties have set their respective hands to this Agreement on the day, month and year lastwritten hereinbelow.



MISTRAL SOLUTIONS PVT LTD


11/7/19

NATIONAL ENGINEERING COLLEGE

By: _____

Name: VINAY BHARAT S

Title: ASSOCIATE VICE PRESIDENT

Date: 11.7.2019

By: _____

Name: M. K. KALIDASA MURUGAVEL

Title: PRINCIPAL

Date: 11.7.2019

TESSOLVE SEMICONDUCTOR TEST ENGINEERING LAB FOR STE-SDC COURSE

Training Partner Agreement Between Tessolve & National Engineering College, Kovilpatti

April 1, 2022

Tessolve Semiconductor Pvt Ltd

Plot No. 31 (P2), Electronic City Phase II

Bangalore 560100, India

T: +91 80 4181 2626

F: +91 80 4120 2626

W: www.tessolve.com

TESSOLVE SEMICONDUCTOR PVT. LTD.

Plot No.31 (P2), Electronic City, Phase II, Bangalore - 560 100, INDIA T: +91 80 4181 2626 F: +91 80 4120 2626
W: www.tessolve.com CIN: U72300KA1993PTC034929 ISO 9001 : 2015

Background

Semiconductor devices today integrate a wide range of components of an electronic system (computation engine, memory, logic, power management, mixed signal blocks etc.) into a single multifunctional device. There is incredible convergence between handheld, automotive, and home electronics technologies. The semiconductor Industry is also levered strongly to the growth prospects of Internet of Things and Big Data. The SoC market is expected to grow from \$500 billion in 2015 to over \$1.5 trillion in 2019.

Testing a chip is a critical step in the design cycle for semiconductor IC companies. Today's chip testing involves high cost equipment and experienced engineers. The Indian market is also now moving towards making our own physical chip, which will require testing, characterization and qualification in India. Not only the big chip makers but also Indian origin design houses and IP providers will need testing of their devices to contribute to the upcoming chip manufacturing in India.

Semiconductor Automated Test Equipment (ATEs) are used for testing memory, digital, mixed signal, power management and SoC components, both at the wafer level and package level stages.

Engineering graduates, who comprise two-thirds of the entire workforce, form a major part of the Semiconductor testing industry. **The industry goes through six months to a year for the Engineering graduates from college to become deployable and industry ready.** There is a continuous shortage and high demand for qualified test engineers every year. Meanwhile, university and engineering institutions lack the specialized ATE training skills, as they cannot afford the financial outlay for high cost Semiconductor Test Equipment required for such training.

Tessolve & ADM have overcome this academia problem by providing a novel concept of owning a low cost Digital Test Trainer – **LGLiteATE** by the Institution (referred as Training Partner). To understand the electronics and device test theory, LGLiteATE is the ideal training vehicle to learn and develop the talent and skillset for the Semiconductor Engineering industry.

Tessolve Semiconductor is offering **Semiconductor Test Engineering - Skill Development Course [STE-SDC] certification course** that will be offered to the Training Partner's teaching faculty so that they can train their students at their campus. The rationale behind this STE-SDC Certification approach is to introduce the students as soon as possible to real world test program development so that they can bridge the gap between academic learning and job-oriented skill set required in the industry in a shorter duration.

Tessolve & ADM will continue to work with Indian academia to support skill-oriented training in field of semiconductor test and measurement.

TESSOLVE SEMICONDUCTOR PVT. LTD.

Plot No.31 (P2), Electronic City, Phase II, Bangalore - 560 100, INDIA T: +91 80 4181 2626 F: +91 80 4120 2626
W: www.tessolve.com CIN: U72300KA1993PTC034929 ISO 9001 : 2015

Training Partner Agreement

This Agreement, effective **1st April, 2022**, is between Tessolve Semiconductor Pvt Ltd, having an office at Plot No. 31 (P2), Electronic City Phase II, Bangalore 560100 and National Engineering College, having an office at Kovilpatti.

The National Engineering College, henceforth known as the "Training Partner" hereby agrees to participate in setting up a Tessolve Semiconductor Test Engineering Lab and offer the STE-SDC course for final year engineering graduates, subject to the following guidelines.

1. Objective

The objective of TSTE Lab is to offer **STE-SDC** Course to ECE/EEE/IE undergraduate students.

2. Term

The term of this Agreement shall be for Three (3) Years commencing on 1st April , 2022, renewable by the parties with mutual consent.

3. Terms & Conditions for setting up the TSTE Lab and conducting the STE-SDC course

- a) Tessolve selects the Training Partner based on factors like qualification of the training staff, location and capabilities to handle the training.
- b) ADM & Tessolve will train the Trainers once the qualified college signs the Training Partner Agreement.
- c) Tessolve will recommend the batch size depending on the infrastructure provided by the Training Partner. Multiple batches can be conducted in case of large enrolment.
- d) Tessolve will provide the course content to be used by the Training Partner.
- e) The Training Partner will be responsible for enrolment of the candidates and getting a batch approved from Tessolve before start of the training.
- f) Training Partner will be responsible for conducting the training and coordination with Tessolve for the assignments.
- g) Tessolve will carry out periodic visits to the TSTE Lab for assessments during the STE-SDC training.

TESSOLVE SEMICONDUCTOR PVT. LTD.

Plot No.31 (P2), Electronic City, Phase II, Bangalore - 560 100, INDIA T: +91 80 4181 2626 F: +91 80 4120 2626
W: www.tessolve.com CIN: U72300KA1993PTC034929 ISO 9001 : 2015

- h) Training Partner will maintain day-wise attendance record for the batch and provide it to Tessolve during the assessments.
- i) The STE-SDC Certification course can be offered full time or part time.
- j) The Training Partner will conduct STE-SDC examination at the end of the course.
- k) Training Partner will **promote training in Semiconductor Test Engineering** to their own students and can also promote it to other nearby Engineering Colleges.
- l) All candidates, upon successfully qualifying Tessolve's examination, will be provided STE-SDC Certification. They will also become **eligible to appear for Technical interview directly at Tessolve** without having to go through a written test selection that is normally required during Tessolve's recruitment process.
- m) Training Partner **is allowed to charge** a nominal fee from students.
- n) Tessolve shall participate in delivering Technical Lectures on Semiconductor Test Engineering Topics by delegates from the industry.
- o) Students hired by other organizations will not be eligible for STE-SDC Training.
- p) Based on Tessolve's hiring requirement from time-to-time, Tessolve should be given the highest priority to hire the required number of students who have qualified from the STE-SDC Training batch.
- q) Tessolve Semiconductor Test Engineering Lab includes STE-SDC courseware and ADM's LGLiteATE, Universal Load board, test scripts and laboratory materials. After successfully obtaining the STE-SDC Certification by Tessolve, the engineer will be able to demonstrate Proficiency in Test Methodologies like test program development and troubleshooting skills for digital ICs.
- r) Tessolve holds the right to withdraw the permission to setup/operate the TSTE Lab at any time if the Training Partner fails to comply with the above guidelines.

4. Other Engagements

The Training Partner agrees that they would conduct trainings with this objective only under the association with Tessolve. During the validity of this Partner Agreement and even after the validity is over, in case the Training Partner intends to associate with any other organization for conducting a similar training, they should first seek a written permission from Tessolve before making any plan.

TESSOLVE SEMICONDUCTOR PVT. LTD.

Plot No.31 (P2), Electronic City, Phase II, Bangalore - 560 100, INDIA T: +91 80 4181 2626 F: +91 80 4120 2626
W: www.tessolve.com CIN: U72300KA1993PTC034929 ISO 9001 : 2015



5. Termination

Either party, upon giving not less than thirty (30) days written notice, may terminate this Agreement. The thirty (30) day termination period shall not begin until the other party has received or is deemed to have received the notice of termination.

6. Entire Agreement

This agreement constitutes the entire agreement and final understanding of the parties with respect to the subject matter hereof and supersedes and terminates all prior and/or contemporaneous understandings and/or discussions between the parties, whether written or verbal, express or implied, relating in any way to the subject matter hereof. This Agreement may not be altered, amended, modified or otherwise changed in any way except by a written agreement, signed by both parties.

7. Confidentiality

Training Partner agrees at all times during the term this Agreement and after the termination of this Agreement to hold in strictest confidence, and not to use, or to disclose, transfer or reveal, directly or indirectly to any person or entity any Confidential information without the prior written authorization of the other party. Confidential Information includes, but not limited to, Training Material, Manuals, Circuit diagrams, Presentation PPTs, names of investors, buyers, sellers, borrowers, client lists, financial information and trade secrets about the products and information or other proprietary information relating to designs, formulas, developmental or experimental work, know how, products processes, computer programs, source codes, databases, designs, schematics, or other original works of authorship.

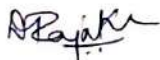
Each party hereby agrees that all information provided by the other party and will be treated as confidential and the receiving party shall not make any use of such information other than with respect to this Agreement. If the Agreement shall be terminated, each party shall return to the other all such confidential information in their possession, or will certify to the other party that all of such confidential information that has not been returned has been destroyed.

8. Assignment

This Agreement is valid only for the Training Partner who have signed with Tessolve, and is not transferable or sub-contractible to any other third person or entity.

TESSOLVE SEMICONDUCTOR PVT. LTD.

Plot No.31 (P2), Electronic City, Phase II, Bangalore - 560 100, INDIA T: +91 80 4181 2626 F: +91 80 4120 2626
W: www.tessolve.com CIN: U72300KA1993PTC034929 ISO 9001 : 2015



IN WITNESS WHEREOF, M/s. Tessolve Semiconductor Pvt. Ltd. and the Training Partner have entered into this agreement and agree to the above terms in their entirety.

For Tessolve Semiconductor Pvt. Ltd.



Mr. Rajakumar D

Vice President – Operations

For National Engineering College



Mr. Leeladasa Mookherjee

Designation Principal

**PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI - DIST.**



NON-DISCLOSURE AGREEMENT

This Agreement is effective on this 7th, September, 2021, by and between **Mistral Solutions Private Limited**, a company incorporated under the Companies Act, 1956 and having its office at No 60, Adarsh Regent, 100 Feet Ring Road, Domlur Extension, Bangalore 560 071 (hereinafter referred to as "MISTRAL"), and **National Engineering College, K.R.Nagar, Kovilpatti-628 503** (hereinafter referred to as "NEC").

(Hereinafter individually referred to as "Party" and collectively referred to as "Parties".)

RECITALS:

- A. The Parties hereto are desirous of having a business relationship and for this purposes are having preliminary negotiations to arrive at a possible business relationship and need to exchange certain confidential information, which could be critical and peculiar to their respective businesses.
- B. This Agreement seeks to determine the nature and regulate the disclosures made by the Parties hereto of confidential information in connection with the negotiations between the Parties for NEC MISTRAL TECHNOBATION CENTER (hereinafter "the Purpose").

NOW IT IS HEREBY AGREED AS FOLLOWS:

1. The Parties agree to execute this Agreement and be bound by the terms and conditions hereof as a precondition to the proposed negotiations and related discussions and agreement between the Parties for the Purpose.
2. "Confidential Information" shall mean all information, know-how, ideas, designs, documents, concepts, technology, manufacturing processes, industrial, marketing, commercial knowledge, and other materials of a confidential nature and includes but is not limited to, information of a commercial, technical or financial nature which contains amongst other matters, trade secrets, know-how, patent, IPRs and ancillary information and other proprietary or confidential information, regardless of form, format, media including without limitation written or oral, and also includes those communicated or obtained through meetings, documents, correspondence or inspection of tangible items, facilities or inspection at any site or place including without limitation:
 - i) research, development or technical information, confidential and proprietary information on products, intellectual property rights;
 - ii) business plans, operations or systems, financial and trading positions;
 - iii) details of customers, suppliers, debtors or creditors;

- iv) Information relating to the officers, directors or employees of the Disclosing Party;
 - v) formulae, IPRs, patterns, compilations, programmes, devices, methods, techniques; or processes, that derive independent economic value, actual or potential, from not being generally known to the public.
3. Except as otherwise provided in this Agreement, the Party receiving Confidential Information ("Receiving Party") shall keep confidential all information of the Party disclosing Confidential Information ("Disclosing Party") which: (a) is disclosed, communicated or delivered to the Receiving Party in furtherance to the Purpose for which the Parties are entering into negotiations and related discussions; or (b) comes to the Receiving Party's knowledge or into the Receiving Party's possession in connection with negotiations and related discussions for the Purpose.
 4. If the Confidential Information is provided in a tangible form, the Disclosing Party shall clearly mark it CONFIDENTIAL. If the Confidential Information is provided in electronic or other media, all information or data contained therein shall be assumed to be confidential or proprietary information of the Disclosing Party and shall be treated as such under the terms of this Agreement. If the Confidential Information is provided orally or in any other intangible form, then the Disclosing will be required to intimate at the time of such disclosure that the same is Confidential and also send a brief written communication describing the Confidential Information disclosed clearly marking the same as CONFIDENTIAL.
 5. The Receiving Party hold such Confidential Information in confidence, shall restrict disclosure of such Confidential Information only to those of its are advised of the obligations assumed herein and who (i) have a "need to know" such Confidential Information in order to enable Receiving Party to use such Confidential Information for the Purpose and (ii) are legally bound to use and disclose such Confidential Information for no other purpose. Receiving Party shall not disclose Confidential Information to any third party without prior written approval of the Disclosing Party, and shall protect such Confidential Information by using the same degree of care (which shall be no less than reasonable care) to prevent its unauthorized disclosure as the Receiving Party uses to protect its own confidential information of a like nature.
 6. The Receiving Party shall not use or permit to be used such Confidential Information for the gain or benefit of any party other than the Disclosing Party or for the Receiving Party's personal gain or benefit outside or in circumvention of the scope of the engagement by Disclosing Party.
 7. These restrictions on the use or disclosure of Confidential Information shall not apply to any Confidential Information: (i) which is independently developed by the

Receiving Party as evidenced by documentation in Receiving Party's possession; or (ii) which is lawfully received from another source free of restriction and without breach of this Agreement; or (iii) after it has become generally available to the public without breach of this Agreement by the Receiving Party; or (iv) which at the time of disclosure to the Receiving Party was known to such party free of restriction as evidenced by documentation in Receiving Party's possession; or (v) which is required to be disclosed by a government agency, by law or by court order.

8. The Receiving Party agrees that it will not directly or indirectly involve or associate itself in any manner or use the Confidential Information, whether provided by the Disclosing Party or acquired by joint efforts, in any manner other than in pursuance of this Agreement or take any step or act in any manner to circumvent the provisions of and the intent of this Agreement or in any manner adverse to the Disclosing Party's interest.
9. This Agreement shall be in effect for a period of two years unless sooner terminated in writing by either party. The Receiving Party agrees that all of their obligations undertaken herein with respect to Confidential Information received pursuant to this Agreement shall survive and continue 5 years after any expiration or termination of this Agreement.
10. No license to Receiving Party, under any trademark, patent, copyright, or any other intellectual property right, is either granted or implied by the conveying of Information to Receiving Party. None of the Confidential Information which may be disclosed by Disclosing Party shall constitute any representation, warranty, assurance, guarantee, or inducement by Disclosing Party to Receiving Party of any kind, and in particular, with respect to the non-infringement of trademarks, patents, copyrights or any intellectual property rights or other rights of third persons.
11. Neither this Agreement nor the disclosure of Confidential Information shall constitute or imply any promise to or intention to make any purchase of products or services by Disclosing Party, or any commitment by Disclosing Party with respect to the present or future marketing of any product or service.
12. The Receiving Party agrees not to announce nor disclose to any third person or party their participation in discussions concerning the Information or the nature of any such discussions without first securing the prior written approval of the Disclosing Party.
13. All Confidential Information shall remain the property of the Disclosing Party and all copies thereof, on whatever physical, electronic or other media such Information may be stored, shall be returned within five (5) business days of the Disclosing

Party's request or upon the Receiving Party's determination that it no longer has a need for such Confidential Information.

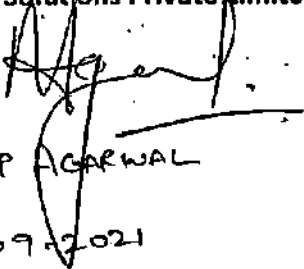
14. The Disclosing Party has no obligation to disclose Confidential Information to the Receiving Party. The Disclosing Party may, at any time: (i) cease giving Confidential Information to the Receiving Party without liability, and/or (ii) request in writing the return of Confidential Information previously disclosed.
15. Each Party shall not use any information obtained under this Agreement to directly or indirectly solicit, recruit, hire, entice or engage any employee, consultant, or independent contractor of the other Party to leave the employment of the other Party or terminate its relationship with the other Party for any purpose whatsoever, whether for the Party benefited or benefit of a third party.
16. This Agreement constitutes the entire understanding between the parties hereto and supersedes all previous communications, representations and understandings, oral or written, between the parties with respect to the subject matter of this Agreement.
17. No amendment or modification of this Agreement shall be valid or binding on the parties unless made in writing and signed on behalf of each of the parties by their respective duly authorized officers or representatives.
18. Subject to the limitations set forth in this Agreement, this Agreement will inure to the benefit of and be binding upon the parties, their successors and assigns provided however, that no assignment by the Receiving Party shall be made or effective without the written consent of the Disclosing Party.
19. Receiving Party further agrees that money damages may not be a sufficient remedy for any breach of this Agreement and that in addition to all other remedies, the Disclosing Party may be entitled to specific performance and injunctive or other equitable remedies from a court of competent jurisdiction as a remedy for any such breach.
20. If any provision of this Agreement shall be held by a court of competent jurisdiction to be illegal, invalid or unenforceable, the remaining provisions shall remain in full force and effect.
21. This Agreement shall be governed by, and construed in accordance with, the laws of India and the courts of Bangalore shall have exclusive jurisdiction.

22. This Agreement may be executed in one or more counterparts, each of which shall be an original but all of which shall constitute one and the same Instrument. Signatures to this Agreement may be exchanged by facsimile. Any facsimile reproduction of the signature of either party shall be admissible as evidence of the original signature itself in any judicial or administrative proceeding, whether or not the original is in existence.

IN WITNESS WHEREOF, the parties have caused this Agreement to be signed by their duly authorized representatives as of the date first set forth above.


Mistral Solutions Private Limited

By:


ANOOP AGARWAL
CFO
08-09-2021

National Engineering College

By:


Dr. K Kalidasa Murugavel
Principal
07.09.2021

भारतीय गैर न्यायिक

बीस रुपये

रु.20



Rs.20

TWENTY
RUPEES

INDIA NON JUDICIAL

RS20/-

தமிழ்நாடு தமில்நாடு TAMIL NADU

21.09.2022

CADD TECHNOLOGIES SCHOOL OF
-DESIGN PVT LTD
COIMBATORE.

PL.KARTHIKA
STAMP VENDOR
L.No: 928/B1/2021-32/CBE
Peelamedu,
Coimbatore-641004.

01AC 941031

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding made and executed on this 23rd day of Sep 2022

BETWEEN

M/s CADD Technologies School of Design Private Limited, having its Registered office at ,27/2 Rajai Road, Ram Nagar, Gandhipuram, Coimbatore - 641 009 ,represented by its Executive Director Mr. N. Venkatraman hereinafter referred to as the "Service Provider".

AND

M/s National Engineering College, K.R. Nagar, Kovilpatti - 628503, represented by its Principal, Dr. K. Kalidasa Murugavel hereinafter referred as "Client".

CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED

N. Venkatraman

DIRECTOR.

K. Kalidasa Murugavel
Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

Page 1

The Service Provider and Client shall, unless repugnant to the context or meaning thereof, include its successors and permitted assigns

WHEREAS, The Service Provider is in the business of Training, Project Support in the field of CAD/CAM/CAE for more than two decades and Providing training on CAD/CAM/CAE/IT software training at various Engineering Colleges of Tamil Nadu and Pudhucherry. The service Provider was an Authorized Academic Partner of M/s. Autodesk, M/s. Parametric Technology Corporation (PTC), M/s. Bentley in Tamil Nadu.

WHEREAS, The Service Provider is setting up Training Programs for which it has approached the Client to provide facilities on a mutually beneficial basis;

WHEREAS, The Client has expressed its interest in running the Training Programs at its premises and is committed to working towards making it a success; and

NOW THEREFORE, in consideration of the mutual covenants and agreements herein contained, the parties hereto agrees as follows:

1. SERVICES PROVIDED

In order to meet the increasing demand of technical students, the Service Provider has come out with a proactive program to share its knowledge with the students at the Client's location. The Service Provider has agreed to manage and run the training Program effectively and successfully at the Client's premises.

2. GENERAL TERMS OF SERVICE

a. The Service Provider will manage and run courses on CAD/CAM/CAE at the Client's premises for a period of three years as per the details furnished below.

S.No	Department	Programme on	Proposed for
1	B.E. Civil Engineering	AutoCAD Revit Architecture Revit MEP 3Ds Max STAAD .Pro Primavera BIM	1 st , 2 nd , 3 rd & 4 th year students of Civil Engineering

b. All correspondence between the Service Provider and the Client will be done in writing. The Client will nominate an authorized person who will be the figurehead for all future correspondence.

For CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED


DIRECTOR.


Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

- c. A program schedule will be provided by the Service Provider to the Client within 7 days of signing of this agreement. This schedule will be designed in close coordination with Client's authorized person.
- d. All items related to course schedule, fee and payment schedule are present in **Annexure A** of this document.

3. OBLIGATIONS OF THE SERVICE PROVIDER

- ✓ The Service Provider will run courses by their Authorized and well trained personals at the Client's premises. This course will run for **B.E Civil Engineering 1st, 2nd, 3rd & 4th Year students**. All resources required in terms of course delivery, trainers, content required, hands-on training materials and E courseware (Work Book) will be provided to the students by the Service Provider.
- ✓ Placement Assistance will be provided.
- ✓ Faculty Development Program which will be conducted by **Certified Professionals** on latest tools.
- ✓ Workshop or Technical Seminar to the students will be given at free of cost.
- ✓ Joint promotional Activity will be done for student Design contest based according to the feasibility of both Service Provider and Client.

4. OBLIGATIONS OF THE CLIENT

- a. In order to make the Training Program, a great success a minimum of 50 students per Programme is required to be enrolled. The Client will ensure that an enrollment reaches 50 prior to commencement of the course. The Client will provide no cost to the Service Provider relevant publicity measures in order to meet the minimum requirement of 50 students of the Programme.
- b. The Client shall also provide the necessary infrastructure required for the program. These include necessary classrooms, computer labs with necessary software, projectors and other reasonable infrastructure required for the commencement of the course itself.
- c. The Client will undertake all measures towards effective collection of fees for the Programme conducted by the service provider, details of fee structure are documented in **Annexure A**.
- d. The Client will settle the payment to the Service Provider as per the terms and conditions agreed mutually without any delay till the contract is over.
- e. The Client will be providing necessary accommodation and food arrangements for the trainers agreed mutually.

For CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED


DIRECTOR.


Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

5. TERM OF THE CONTRACT

The Service Agreement will be valid for a term of three years from the date of signing of this agreement and further extension of MOU can be done on mutual consent.

6. TERMINATION BY THE SERVICE PROVIDER AND THE CLIENT

The agreement may be terminated by giving three months written notice after settling dues from either side (if any). If the Client or the Service Provider forms the opinion on reasonable ground, that mutual confidence and trust do not exist between them (or) both the part do not comply this agreement.

7. CERTIFICATION

The successful candidate will avail certificate as per Annexure A. The service Provider will facilitate in conducting the evaluation examination and obtaining certificate.

8. MUTUAL SUPPORT AND COOPERATION

Both the Service Provider and the Client agree that it will take all steps reasonably necessary, at their own expense, to;

- a. To designate key individuals to perform its obligations here under.
- b. The conduct periodic meetings of all such key individuals and others as necessary.
- c. To fully cooperate with all reasonable requests for assistance.

The parties will make diligent efforts through their respective key employees to identify the causes of any problems in the services and to make adjustments, in an equitable manner, in order to address and resolve such problems.

9 NON DISCLOSURE

The Client undertakes not to disclose or allow to be disclosed or copy or allow to be copied any material, collateral, training guides, books or manuals, strategies etc provided by the Service Provider to any other third party or institutions.

10 NON SOLICITATION

The Service Provider and the Client recognize that their individual employees, consultants and other resource personnel are invaluable assets for the respective organizations and undertake that they will not recruit, attempt to recruit, employ or offer any work or consulting to any employee, consultant or resource person from each other's organizations either directly or indirectly during the MoU period.

For CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED


DIRECTOR.


Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

11 NOTICES

All notices, requests, demands and other communications under this agreement or in connection herewith shall be given to or made upon the respective parties as follows:

a) On behalf of Service Provider

b) on Behalf of Client

For CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED


DIRECTOR.

Signature/ Seal


Name: N.Venkatraman
Designation: Executive Director


Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503.
THOOTHUKUDI-DIST

Signature/ Seal

Name: Dr. K.Kalidasa Murugavel
Designation: Principal

Witness:-

1. 
[A. PENAZ AHAMED]
S/o A. Abbas ali,
5, Palkvasal street,
Brahmapukhira Nagar,
Devarayan palayam,
Avinashi - 641 654.

1.

Annexure A

Schedule

The programme(s) will be conducted during the working hours or holidays or during vacation at college campus itself as per the schedule agreed mutually.

Course Fees

S.No	Programme On	Certified By	Cost/Student	Duration in Hrs
01.	Autodesk AutoCAD	M/s. CADD TECHNOLOGIES	Rs. 1500 + 18% GST	40 Hrs
02.	Revit Architecture	M/s. CADD TECHNOLOGIES	Rs. 1500 + 18% GST	40 Hrs
03.	Revit MEP	M/s. CADD TECHNOLOGIES	Rs. 3000 + 18% GST	40 Hrs
03.	3Ds Max	M/s. CADD TECHNOLOGIES	Rs. 1500 + 18% GST	40 Hrs
04.	Primavera	M/s. CADD TECHNOLOGIES	Rs. 2000 + 18% GST	50 Hrs
05.	STAAD .Pro	M/s. CADD TECHNOLOGIES	Rs. 1750 + 18% GST	50 Hrs
06.	BIM 360	M/s. CADD TECHNOLOGIES	Rs. 2500 + 18% GST	40 Hrs.

Minimum number of students - 50 students per batch

Note:

1. The course fee shall be paid as per the following schedules:-

- ✓ The Course fee of 50% shall be paid on commencement of Programme.
- ✓ Final 50% of the course fee to be paid on successful completion of Training Programme and Submission of Students Certificates.

For CADD TECHNOLOGIES SCHOOL OF DESIGN PRIVATE LIMITED


DIRECTOR.


Dr. K. Kalidasa Murugavel, M.E., Ph.D.,
PRINCIPAL
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503,
THOOTHUKUDI-DIST



2022 தமிழ்நாடு தமில்நாடு TAMILNADU

NATIONAL ENGINEERING
COLLEGE
KOVILPATTI

26.05.23

DB 094452

M. Jeyasankari, MCA,
SRO STAMP VENDOR,
KOVILPATTI LNO: 11/2021

PREAMBLE

Whereas, National Engineering College, K.R. Nagar, Kovilpatti, Thoothukudi District, Tamil Nadu – 628503(NEC) has various engineering, technology and science department is charged with responsibility of training technical and scientific manpower in various front-line areas of importance for the Nation and is also contributing to the rapidly growing scientific and technological knowledge and professional excellence in Science & Technology by undertaking industrial & applied research and consultancy.

Whereas, Vlinder Labs Pvt.Ltd, TERRACE FLOOR, 837, 11TH CROSS, 26th Main Rd, 1st sector HSR Layout, Bengaluru, Karnataka 560102 (VLINDER) is a startup with a vision to enable businesses to harness the power of Blockchain through its state of the art and innovative platforms.

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[Handwritten signature]
30/5

S.M. Daliraj

In continuation with Memorandum of Understanding (MoU) had been already signed between NEC and VLINDER (Ref: By CS126070 /Dt.03.03.2022), The MoU is hereby amended to include the following:

1. NEC has agreed that it shall provide necessary infrastructure to setup the NEC-Vlinder Technology Incubation Centre (Technobation Centre) at the first floor of Electronics and Communication Engineering Department, National Engineering College, K.R.Nagar, Kovilpatti, Thoothukudi District, Tamil Nadu- 628 503 with Vlinder office build up area of 918.04Square feet which consist of , software lab , block chain Lab and discussion room.
2. Vlinder will use Vlinder technobation centre for Vlinder internal Research & Development (R&D), executing commercial customer projects and providing training and internships to students and new joinees.
3. NEC shall provide required infrastructure including building with seating for 30 Engineers , discussion room, manager room, with uninterrupted power supply and water facility to setup Vlinder technobation centre at NEC campus.
4. Vlinder shall agree to manage and operate the Vlinder technobation centre at NEC campus for next 5 years.
5. Vlinder employees, internship students from NEC, may be part of technobation centre.
6. NEC and Vlinder agree to jointly review on need basis and amend any necessary changes to MOU by mutual written consent as may be required to operate the Vlinder technobation centre.
7. During the sixth semester, 20 students will be chosen, and they will receive training in industry-standard tools and technologies. The selection process will be done as a part of Vlinder's campus recruitment process. Shortlisted students for the Technobation will consist of :
 - a. A set of students with an internship and employment offer
 - b. Remaining students with an internship offer only
8. Full-time training is suggested to be held every Saturday and, if necessary, one Sunday per month. Alternatively, the internship schedule may be managed as 2 hours per day during the week days after the class hours.

Leena
30/5

2/5

S.M. Balraj

9. Students under 7-a category above will be given an offer letter as full-time employee with one-year internship stipend of Rs. 15,000/month. However their employment offer is subject to satisfactory performance during internship.
10. **Students having a firm employment offer from Vlinder during their internship would not be allowed to attend campus interview for other companies.**
11. **Students in category 7-b above will be treated as unpaid interns and they may attend campus recruitment of other companies and may get placement offer, under this situation the student will be terminated from the Vlinder Internship. Rest of the unpaid intern students may continue the internship and if they perform well, Vlinder may think of hiring them according to the need.**
12. Vlinder will assign a site manager to communicate with NEC and monitor daily activities.
13. Vlinder will shortlist 3 NEC faculty members and train them to work on consultancy work assigned by them. The commercials for each consultancy work will be agreed upon a case by case basis as a separate agreement.
14. Vlinder and NEC will have a quarterly review on the Technobation Key Performance Index (KPI).
15. Vlinder and NEC will jointly bid for projects that can use Vlinder Products and Platforms.
16. Vlinder will organize talks/seminars to faculty members on Industry trends and Tech Trends each quarter.
17. All IP emanating from the Technobation will belong to Vlinder.
18. Vlinder guaranteed to create a White labelled vlinder digicert platform for NEC to use and issue blockchain-based certificates in August 2023.
19. Vlinder agreed to utilize competent faculties of for their consultancy work from the month December 2023.
20. Vlinder Technobation centre may operate beyond the NEC regular working hours and working days.

Vlinder
30/5



21. Parties agree to provide six months prior written notice to the other Party before terminating this MoU to operate the Vlinder technobation centre. The parties respectively agree to provide the following:



a. NEC shall provide following free of cost.



1. Furniture already existing in the proposed build up area
2. Electricity and UPS
3. Air condition
4. Water
5. Transport(College Bus) and Hostel facility with nominal fee

b. Vlinder should take care of following.

1. Server
2. Wi-Fi & internet
3. Lab Equipment if required
4. Employee Attendance system
5. Video conference
6. Office stationery
7. Coffee & tea
8. PC/Laptop for Employee
9. Telephone
10. Firewall
11. Additional furniture if needed.

For NEC	For Vlinder Labs Pvt.Ltd
	
Name Dr. K. Kalidasa Murugavel, M.E., Ph.D., PRINCIPAL	Name KALIRAJ SUBRA MANIAN
Designation NATIONAL ENGINEERING COLLEGE K.R. NAGAR, KOVILPATTI - 628 503. THOOTHUKUDI-DIST	Designation CHIEF TECHNOLOGY OFFICER

 2015/2023	
Name A. SHENBAGAVALLI	Name S. Madhusudhan.
Designation Professor / EOE dept NEC	Designation Co-Founder, Director

 30/5/23	
Name S. SHANMUGAVEL	Name RAJMOHAN K
Designation Director National Engg. College	Designation Director of Engg Vlinder

Dr. S. SHANMUGAVEL, Ph.D.,
DIRECTOR
NATIONAL ENGINEERING COLLEGE
K.R. NAGAR, KOVILPATTI - 628 503,
THOOTHUKUDI-DIST

भारतीय गैर न्यायिक

बीस रुपये

रु.20



Rs.20

TWENTY
RUPEES

INDIA NON JUDICIAL

தமிழ்நாடு தமில்நாடு TAMIL NADU

Rs. 20/-

NATIONAL ENGINEERING
COLLEGE
KOVILPATTI

17/12/2021

03AC 585598

M. Jeyasankari
M. JEYASANKARI, MCA.
SRO STAMP VENDOR
KOVILPATTI L.NO: 11/2021

MEMORANDUM OF UNDERSTANDING

Between

NATIONAL ENGINEERING COLLEGE, KOVILPATTI

(An Autonomous Institution, affiliated to Anna University, Chennai)

and

M/S QUANTANICS TECHSERV PVT LTD, MADURAI

This agreement entered on 02/01/2022 between the Department of Electrical & Electronics Engineering, National Engineering College (An Autonomous Institution), K.R.Nagar, Kovilpatti (**hereinafter referred to as "NEC"**) and **M/S Quantanics Techserv Pvt Ltd**, having its registered office at Quantanics Techserv Pvt Ltd, Vellaikannu Nagar, Theni Main Road, Maduari-625016 represented by the Managing Director **Mr.T.Karthick** (**hereinafter referred to as "QTPL"**) involved in the design, Software & Application Development for Industry/Organization and also have interest in conducting training, In plant training and internship program.

AND WHEREAS

The parties herein now intend to enter into this MoU to facilitate the following objectives through orientation and development for their mutual benefit.

OBJECTIVES/PURPOSE OF THIS MOU:

- (i) To improve the skill set of engineering students in Software development for Industry.
- (ii) To bridge the gap between college education and industrial requirement.
- (iii) To provide opportunities for the Electrical and Electronics Engineering (EEE) students of the college to undergo industrial trainings through Value Added Courses, In Plant Training and to take up project.
- (iv) To organize the short-term training programs.
- (v) To provide Internship for the students.
- (vi) Guidance for preparation of Projects/Proposals
- (vii) Knowledge Transfer to students/staff for Consultancy Work
- (viii) To provide Industrial Research for the students/staff.
- (ix) To provide In plant Training for the students.

ROLES AND RESPONSIBILITIES OF THE MOU SIGNING COMPANY:

- (i) The Industry shall permit the faculties designated inside their campus for interaction and development of the project.
- (ii) The Industry agrees to participate in curriculum / extra curriculum designing and give guest lecturers for the benefit of students.
- (iii) To organize short term training programs
- (iv) To organize Value Added Courses/Workshop/Seminar once in six months to Electrical and Electronics Engineering (EEE) students at the college to enlighten them on the advance telecom projects and development.
- (v) To supply tools/techniques to the college
- (vi) To provide opportunities for the Electrical and Electronics Engineering (EEE) students of the college to undergo industrial trainings, in plant visits and to take up project works.
- (vii) To provide Internship for best performing Individuals.
- (viii) To identify and help the college in the area of taking up R & D projects.
- (ix) The Company will provide opportunity for placement to the students, if demand exists.

ROLES AND RESPONSIBILITIES OF THE COLLEGE:

- (i) **NEC** will permit the **QTPL** to utilize their facilities.
- (ii) To create the awareness among the students about recent advancement in Electrical and Electronics products.
- (iii) To undertake consultancy works.
- (iv) To provide classrooms /LCD Projectors and audio facilities and laboratory facilities as required for the training.
- (v) To train the employees of QTPL on latest technologies and accommodation and hospitality will be provided by NEC during their training period.
- (vi) To impart theoretical exposure on software's to the employees.
- (vii) **NEC** further agrees to provide their students for market survey and feasibility study analysis work etc., to connect with the Industry in a mutually agreed time frame.

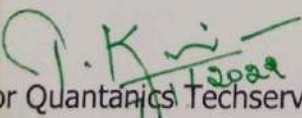
INTELLECTUAL PROPERTY RIGHTS (IPR)

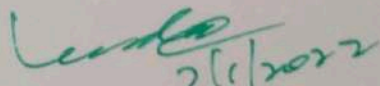
NEC faculty shall maintain integrity of the technique / technology of **QTPL** products and process observed during their visit and consultancy work.

TIME FRAME:

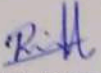
This MoU is valid for 3 years from the date of signing and will be renewed for a further period on mutually agreed terms and conditions.

In witness whereof the parties hereto have affixed their signatures to this agreement on this day.


For Quantanics Techserv Pvt Ltd
Mr.T.Karthick
Managing Director
Quantanics Techserv Pvt Ltd
Vellaikannu Nagar
Theni Main Road
Madurai – 625016

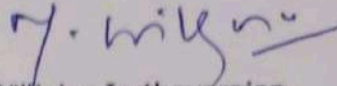

For National Engineering College
Dr.K.Kalidasa Murugavel
Principal
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India– 628503

WITNESSES

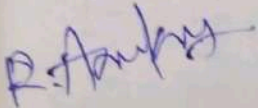


1. Mr.R.Vignesh
CTO
Quantanics Techserv Pvt Ltd
Vellaikannu Nagar
Theni Main Road
Maduari-625016

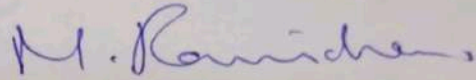
WITNESSES



1. Dr.M.Willjuice Iruthayarajan,
Professor and Head,
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503



2. Mr.V.Ohm Vignesh
Embedded Engineer
Quantanics Techserv Pvt Ltd
Vellaikannu Nagar
Theni Main Road
Maduari-625016



2. Dr. M.Ravindran
Associate Professor(Senior Grade),
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503



தமிழ்நாடு தமில்நாடு TAMIL NADU

மக்கள் : NATIONAL ENGINEERING COLLEGE

மதிப்பு : ரூ.20

ததி : 29.3.2022 MEMORANDUM OF UNDERSTANDING

KOVILPATTI

Between

NATIONAL ENGINEERING COLLEGE, KOVILPATTI

(An Autonomous Institution, affiliated to Anna University, Chennai)

and

M/S ADROIT POWER SYSTEMS INDIA PRIVATE LIMITED, COIMBATORE

This agreement entered on 31/03/2022 between the Department of Electrical & Electronics Engineering, National Engineering College (An Autonomous Institution), K.R.Nagar, Kovilpatti (**here in after referred to as "NEC"**) and **M/S Adroit Power Systems India Private Limited**, having its registered office at S. F. No. 343 & 344, Periyannan Nagar, Vellaikannu Nagar, Edayarpalayam Post, Coimbatore - 641025, represented by the Managing Director **Mr.J.Shanth Kumar** (**here in after referred to as "APSIPL"**) involved in the designing of Power conditioning devices such as Servo Stabilizers, Static Stabilizers, Isolation Transformers, Online UPS ,OVCD (Over Voltage Cutoff Device) etc, and also have interest in conducting training, Inplant training and internship program.

[Handwritten signature]
31/3/22

03AC 599958

P. சிவசுந்தரம்
P. சீரவியம்

S.R.O. எட்டாம்படு வெண்டர்
கோவில்பட்டி.

L. No. B 7/23000/80

AND WHEREAS

The parties herein now intend to enter into this MoU to facilitate the following objectives through orientation and development for their mutual benefit.

OBJECTIVES/PURPOSE OF THIS MOU:

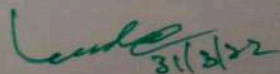
- (i) To improve the skill set of engineering students in Hardware/Software development for Industry.
- (ii) To provide opportunities for the Electrical and Electronics Engineering (EEE) students of the college to undergo industrial trainings through Value Added Courses, In Plant Training and to take up project.
- (iii) To provide Internship for the students.
- (iv) Guidance for preparation of Projects/Proposals
- (v) Knowledge Transfer to students/staff for Consultancy Work

ROLES AND RESPONSIBILITIES OF THE MOU SIGNING COMPANY:

- (i) The Industry shall permit the faculties designated inside their campus for interaction and development of the project.
- (ii) The Industry agrees to participate in curriculum / extra curriculum designing and give guest lecturers for the benefit of students.
- (iii) To organize short term training programs
- (iv) To organize Value Added Courses/Workshop/Seminar once in six months to Electrical and Electronics Engineering (EEE) students at the college to enlighten them on the advance telecom projects and development.
- (v) To supply tools/techniques to the college
- (vi) To provide opportunities for the Electrical and Electronics Engineering (EEE) students of the college to undergo industrial trainings, in plant visits and to take up project works.
- (vii) To provide Internship for best performing Individuals.
- (viii) To identify and help the college in the area of taking up R & D projects.
- (ix) The Company will provide opportunity for placement to the students, if demand exists.

ROLES AND RESPONSIBILITIES OF THE COLLEGE:

- (i) **NEC** will permit the **APSIPL** to utilize their facilities.
- (ii) To create the awareness among the students about recent advancement in Electrical and Electronics products.
- (iii) To undertake consultancy works.
- (iv) To provide classrooms /LCD Projectors and audio facilities and laboratory facilities as required for the training.


31/3/22

- (v) To train the employees of **APSIPL** on latest technologies and accommodation and hospitality will be provided by NEC during their training period.
- (vi) To impart theoretical exposure on software's to the employees.
- (vii) **NEC** further agrees to provide their students for market survey and feasibility study analysis work etc., to connect with the Industry in a mutually agreed time frame.

INTELLECTUAL PROPERTY RIGHTS (IPR)

NEC faculty shall maintain integrity of the technique / technology of **APSIPL** products and process observed during their visit and consultancy work.

TIME FRAME:

This MoU is valid for 3 years from the date of signing and will be renewed for a further period on mutually agreed terms and conditions.

In witness whereof the parties hereto have affixed their signatures to this agreement on this day.

Shanth
31/03/22

For M/S Adroit Power Systems India (P) Limited

Mr.J.Shanth Kumar

Managing Director
M/S Adroit Power Systems India (P) Limited
S. F. No. 343 & 344,
Periyannan Nagar, Vellaikannu Nagar,
Edayarpalayam Post,
Coimbatore

Kalidasa
31/03/22

For National Engineering College

Dr.K.Kalidasa Murugavel

Principal
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503

WITNESSES

1.

Srinivas
Mrs. S. VIMALA (Admin)
110, Saravana Nagar,
Edayarpalayam post,
Coimbatore - 641025

2.

B. Nageswari
Mrs. B. Nageswari (Accounts)
62A, Sivaji Colony,
Edayarpalayam Post
Coimbatore - 641025

WITNESSES

1.

Dr. M. Willjuice
Dr.M.Willjuice Iruthayarajan,
Professor and Head,
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503

2.

M. Ravindran
Dr. M.Ravindran
Associate Professor(Senior Grade),
Department of Electrical and Electronics Engineering,
National Engineering College
K.R.Nagar, Kovilpatti
Tamil Nadu, India- 628503